

GB-1916

GNSS/Bluetooth/BLE Module

Datasheet



Document history

Version	Date	Updates
0.1	July 7, 2017	• Creation.

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1. Introduction

GB-1916 module is a versatile module that integrates GNSS, classic Bluetooth and Bluetooth low energy in a miniature QFN (Quad Flat No leads) form factor. Its built-in highly integrated power management units make not only switch individual features of the power by software commands but also perform brilliant low power consumption. All parts of RF functions are included, such as SAW filter and LNA of GNSS as well as the band pass filter of Bluetooth. No abstruse RF knowledge is required. Just connect antennas to it. Besides, all functions of GNSS, A-GNSS and Bluetooth are software controlled via single UART port. These ease the use, shorten the development time and make the fast time to market.

1.1 Product features

Table 1: Module key features

GNSS feature	Description	
GPS, GALILEO, QZSS	L1 1575.42MHz, C/A code.	
GLONASS	L1 1598.0625MHz ~ 1605.375MHz, C/A code.	Switchable between GLONASS and BEIDOU.
BEIDOU	B1 1561.098MHz, C code.	
SBAS	WAAS, EGNOS, MSAS, SDCM, GAGAN	
A-GNSS	● EPO (Extended Prediction Orbit) data service ● EASY: Embedded Assist System which accelerates TTFF by predicting satellite navigation messages from received ephemeris.	
Channels	Support 99 channels (33 tracking, 99 acquisition)	
Update rate	1 Hz default, up to 10 Hz	
Sensitivity	● Tracking: up to -165 dBm ● Acquisition: up to -148 dBm	
Antenna	Passive or active antenna support	
Bluetooth feature	Description	
Output power	Maximum 4dBm ± 3dBm.	
version	Bluetooth specification v4.0	
Audio	Analog interface. Integrated maximum 0.8W high power class AB speaker amplifier.	
Profile	SPP, HFP, BLE GATT	

1.2 Block diagram

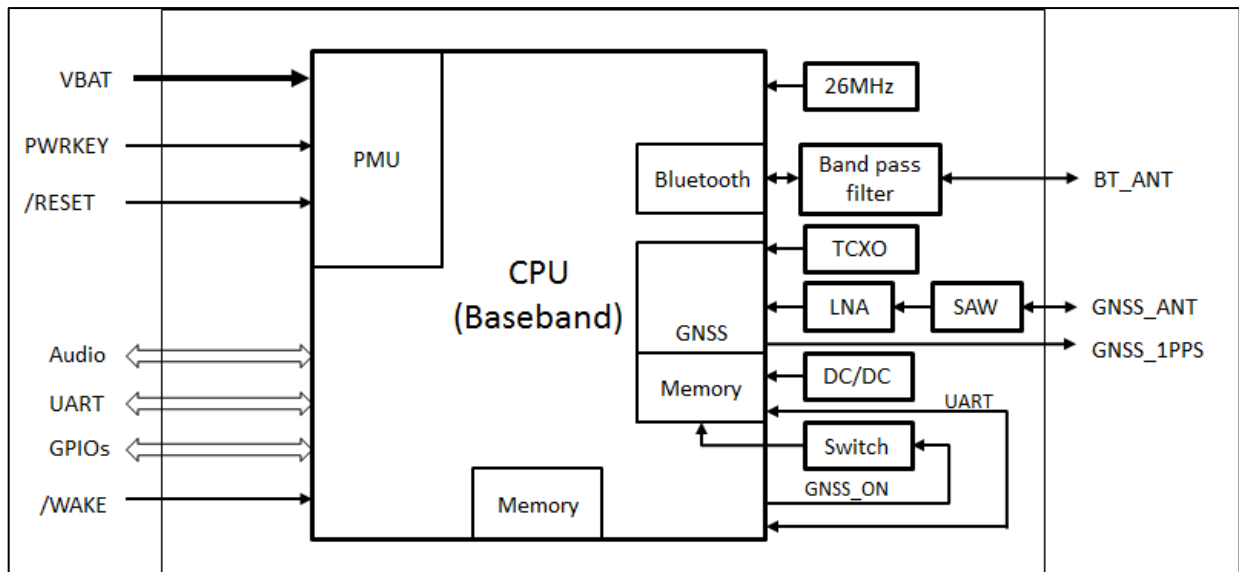


Figure 1: Module block diagram

2. Pin definition

2.1 Pin assignment

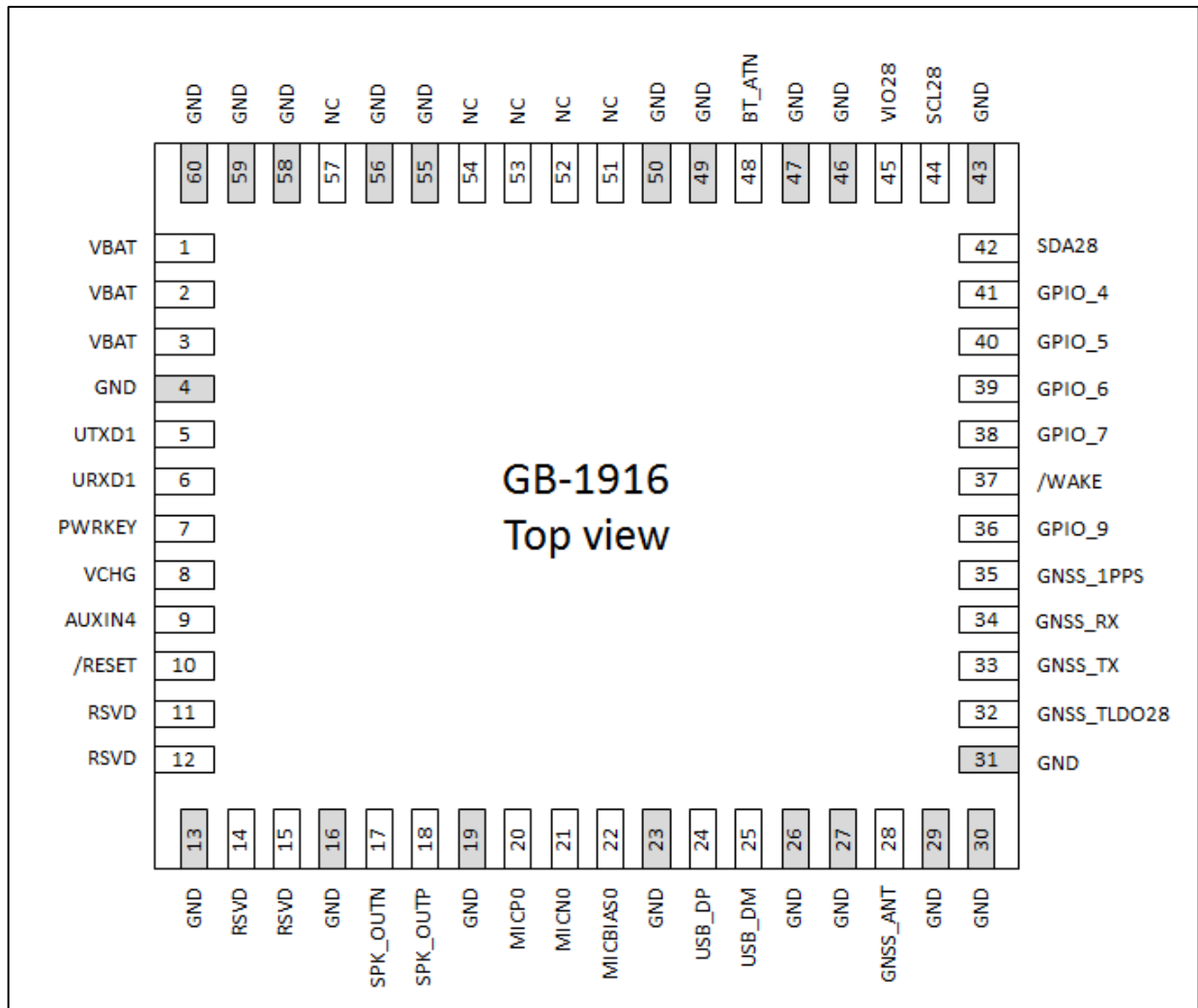


Figure 2: Pin assignment

2.2 Pin description

Table 2: Pin description

Pin #	Name	I/O	Description	Remarks
1	VBAT	I	Power supply input	
2	VBAT	I	Power supply input	
3	VBAT	I	Power supply input	
4	GND		Ground	
5	UTXD1	O	UART transmitted data. Power domain: VIO28.	IO Type 2
6	URXD1	I	UART received data. Power domain: VIO28.	IO Type 3
7	PWRKEY	I	Power on/off key. This pin is internally pulled up to VBAT.	

8	VCHG		Reserved pin. Leave unconnected.	
9	AUXIN4	I	ADC channel	
10	/RESET	O	System reset. Power domain: 1.8V.	
11	RSVD		Reserved pin. Leave unconnected.	
12	RSVD		Reserved pin. Leave unconnected.	
13	GND		Ground	
14	RSVD		Reserved pin. Leave unconnected.	
15	RSVD		Reserved pin. Leave unconnected.	
16	GND		Ground	
17	SPK_OUTN	O	Negative voice output. Class AB, 0.8W @ 3.7V, 8ohm.	
18	SPK_OUTP	O	Positive voice output. Class AB, 0.8W @ 3.7V, 8ohm.	
19	GND		Ground	
20	MICP0	I	Microphone positive input	
21	MICN0	I	Microphone negative input	
22	MICBIAS0	O	Microphone bias output	
23	GND		Ground	
24	USB_DP		Reserved pin. Leave unconnected.	
25	USB_DM		Reserved pin. Leave unconnected.	
26	GND		Ground	
27	GND		Ground	
28	GNSS_ANT	I	GNSS antenna pad (50 ohm impedance)	
29	GND		Ground	
30	GND		Ground	
31	GND		Ground	
32	GNSS_TLDO28	O	2.8V power output for GNSS active antenna. Do not use for the other purposes, otherwise GNSS may fail to function properly.	
33	GNSS_TX	O	GNSS transmitted data. Internally connected to the baseband. For normal operation, please leave unconnected. Power domain: 2.8V.	IO Type 2
34	GNSS_RX	I	GNSS received data. Internally connected to the baseband. For normal operation, please leave unconnected. Power domain: 2.8V.	IO Type 3
35	GNSS_1PPS	O	GNSS 1PPS output, default 100ms pulse/sec when 3D position fix is available. Power domain: 2.8V.	
36	GPIO_9	I/O	General purpose input/output. Power domain: VIO28.	IO Type 2
37	/WAKE	I	Falling edge triggered input with an internal pull-up	IO Type 2

			resistor. Pull this pin from high level to low level to wake up the module from sleep mode. Power domain: VIO28.	
38	GPIO_7	I/O	General purpose input/output. Power domain: VIO28.	IO Type 2
39	GPIO_6	I/O	General purpose input/output. Power domain: VIO28.	IO Type 2
40	GPIO_5	I/O	General purpose input/output. Power domain: VIO28.	IO Type 2
41	GPIO_4	I/O	General purpose input/output. Power domain: VIO28.	IO Type 2
42	SDA28	I/O	I ² C data. Power domain: VIO28.	IO Type 2
43	GND		Ground	
44	SCL28	O	I ² C clock. Power domain: VIO28.	IO Type 2
45	VIO28	O	2.8V power output.	
46	GND		Ground	
47	GND		Ground	
48	BT_ANT	I/O	Bluetooth antenna pad (50 ohm impedance).	
49	GND		Ground	
50	GND		Ground	
51	NC		Not connected	
52	NC		Not connected	
53	NC		Not connected	
54	NC		Not connected	
55	GND		Ground	
56	GND		Ground	
57	NC		Not connected	
58	GND		Ground	
59	GND		Ground	
60	GND		Ground	

3. Electrical specifications

3.1 Absolute maximum rating

Table 3: Absolute maximum rating

Parameter	Symbol	Minimum	Maximum	Unit
Power supply input	VBAT	-0.3	4.3	V
Digital input voltage for IO Type 2	VIN2	-0.3	3.08	V
Digital input voltage for IO Type 3	VIN3	-0.3	3.63	V
Storage temperature	TA _{stg}	-40	85	°C

3.2 Electrical characteristics

Table 4: Electrical characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Power supply input	VBAT		3.4	3.8	4.2	V
TCXO LDO output	TLDO28		2.66	2.8	2.89	V
TCXO LDO output current	I _{TLDO28}				20	mA
2.8V power output	VIO28		2.66	2.8	2.94	V
2.8V output current	I _{VIO28}			50	80	mA
Module peak of current consumption through all VBAT pins	I _{PEAK}				300	mA
Shutdown current	I _{OFF}	Power off		152		μA
High level input voltage	V _{IH}	IO Type 2	2.1		3.08	V
		IO Type 3	2.1		3.6	
Low level input voltage	V _{IL}		-0.3		0.7	V
High level output voltage	V _{OH}		2.38	2.8	2.94	V
Low level output voltage	V _{OL}		0		0.42	V

Table 5: Current consumption of GB-1916

GNSS	Bluetooth	Can CPU sleep ^{*1}	Typical current
Off	Off	No	12 mA ^{*2}
Off	Off	Yes	0.57 mA
Acquisition	Off	Yes	23.7mA
Acquisition	Off	No	34.9 mA
Tracking	Off	Yes	22 mA
Tracking	Off	No	32.7 mA
Off	On, connectable	Yes	0.6 mA
Off	On, connectable	No	12.1 mA
Off	On, connected, idle	Yes	0.84 mA
Off	On, connected, idle	No	12.2 mA

<Note>

1. Sleep mode can be enabled by AT command “AT+LSSLEEP=1”. When CPU is sleep, it cannot respond to any AT commands via URXD1 pin.
2. The module is powered on in the mode of Bluetooth off, GNSS off and CPU sleep disabled.

3.3 Temperature characteristics

Table 6: Temperature characteristics

Parameter	Symbol	Minimum	Typical	Maximum	Unit
Normal operating temperature	T _{opr}	-20	25	85	°C
Storage temperature	T _{stg}	-40	25	85	°C

4.2 Recommended layout pattern

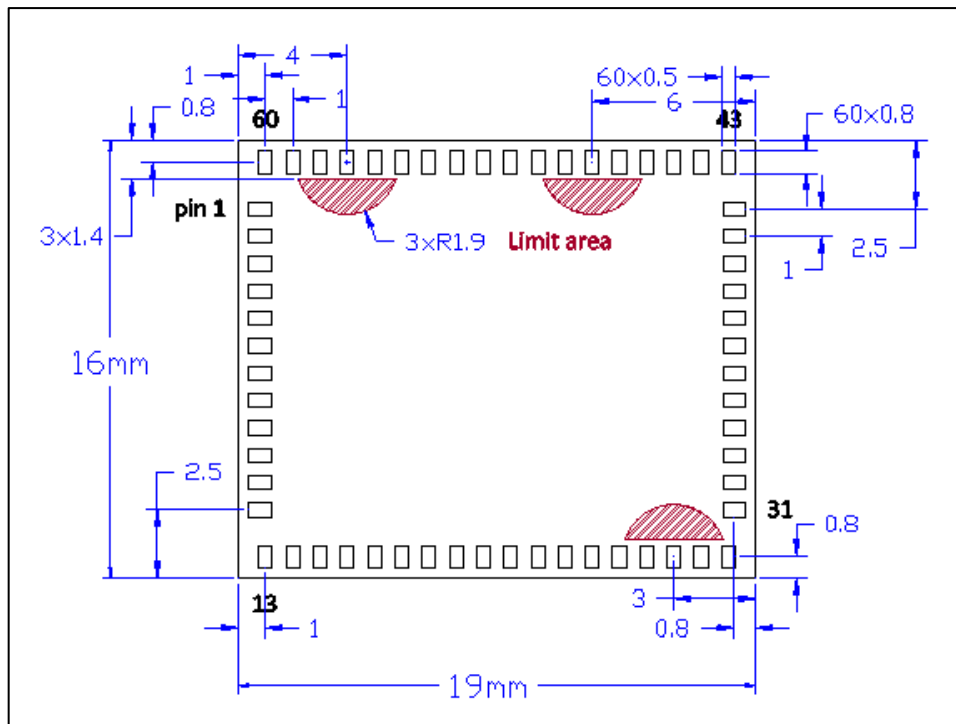


Figure 4: Recommended land pattern dimensions

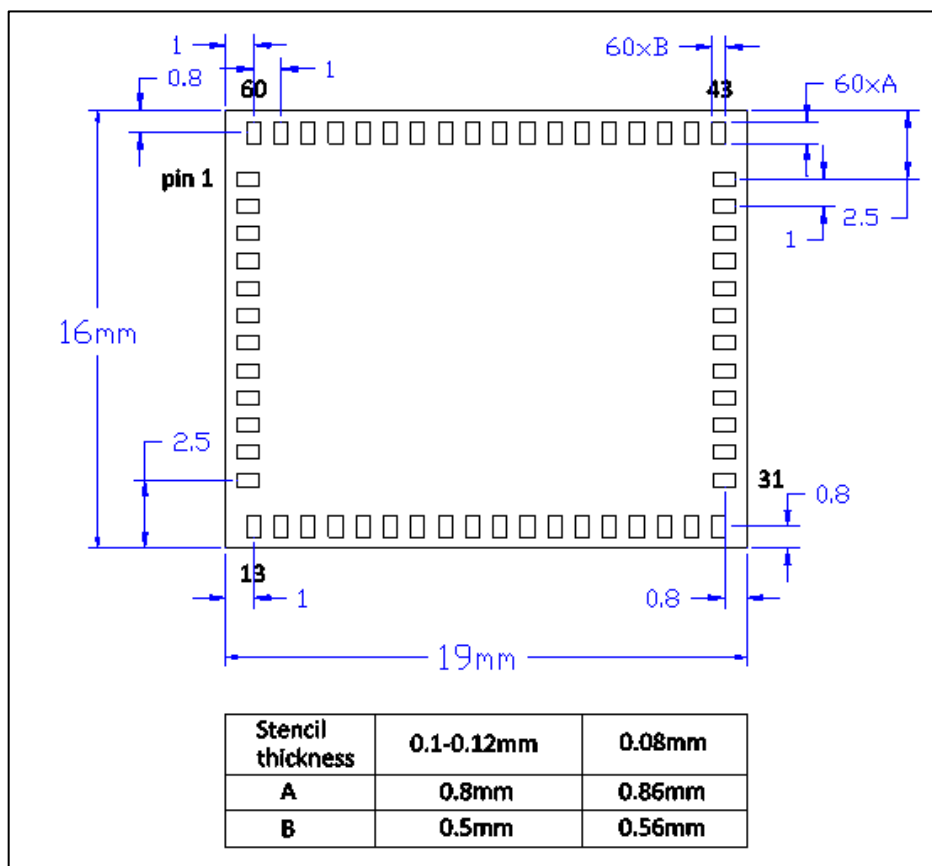


Figure 5: Recommended stencil design

5. Product handling

5.1 ESD precaution

GB-1916 modules are electrostatic sensitive devices. Handling the modules without proper ESD protection may result in severe damage to them. ESD protection must be implemented throughout the processing, handling and even when the modules are being returned for repair.

5.2 Packaging

The modules are sealed in a moisture barrier ESD bag with the appropriate units of desiccant and a humidity indicator card. It should not be opened until the modules are ready to be soldered onto the application.

5.2.1 Tape and reel packaging

The modules are deliverable in quantities of 1,000 pieces on a reel of 330mm in diameter.

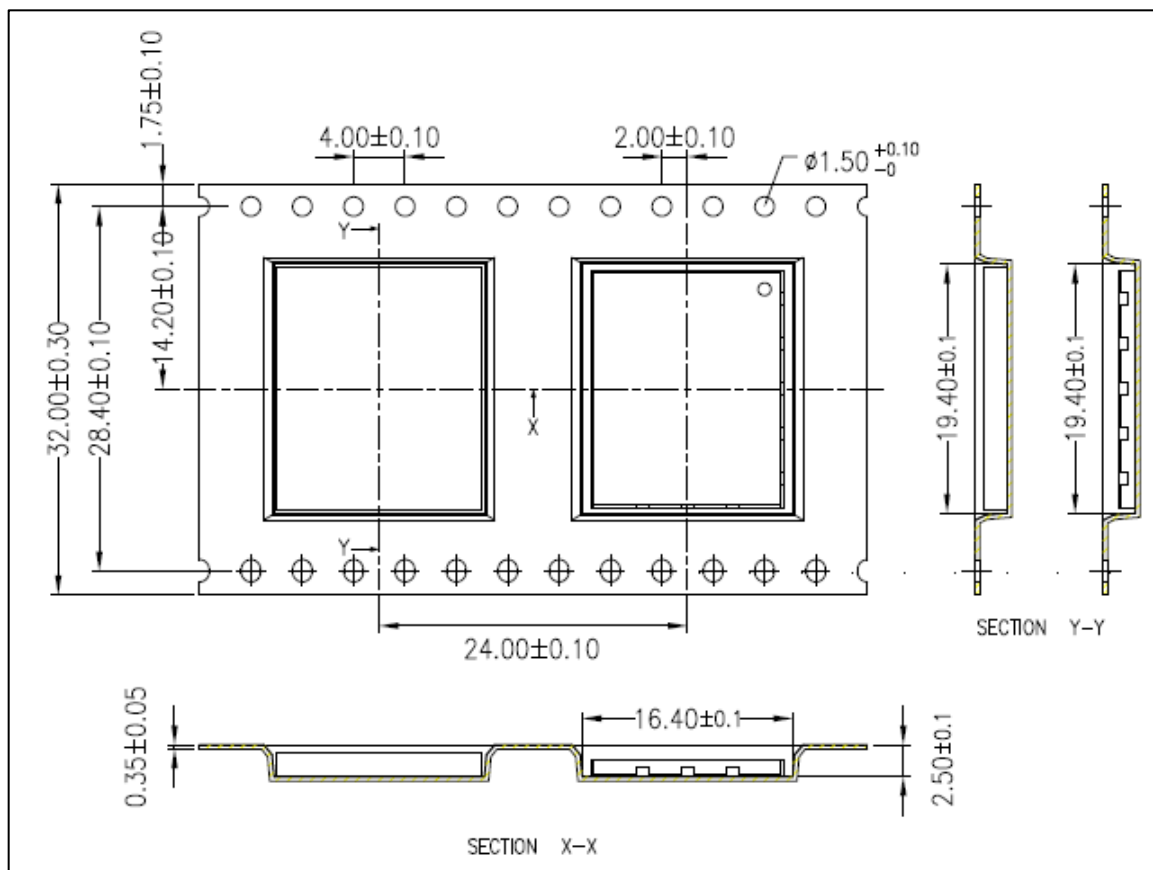


Figure 6: tape dimensions (mm)

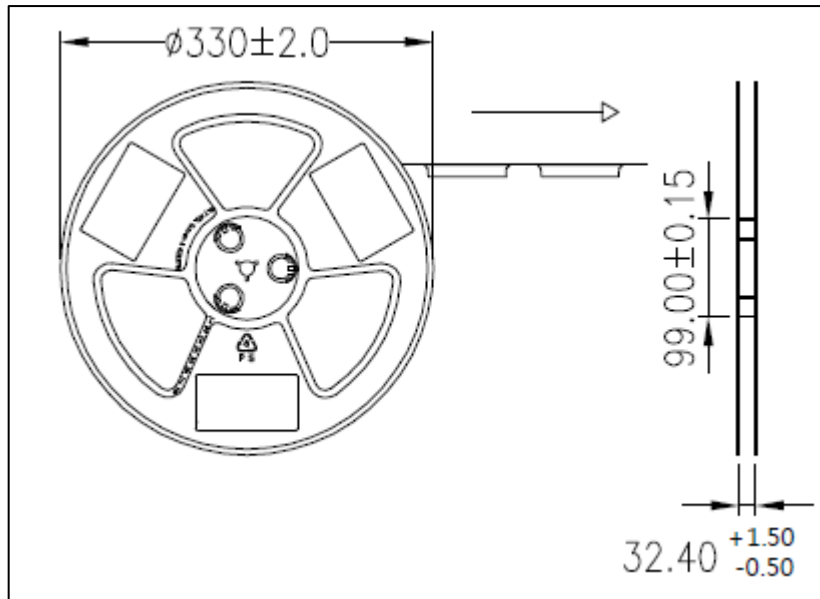


Figure 7: reel dimensions (mm)

5.2.2 Box packaging

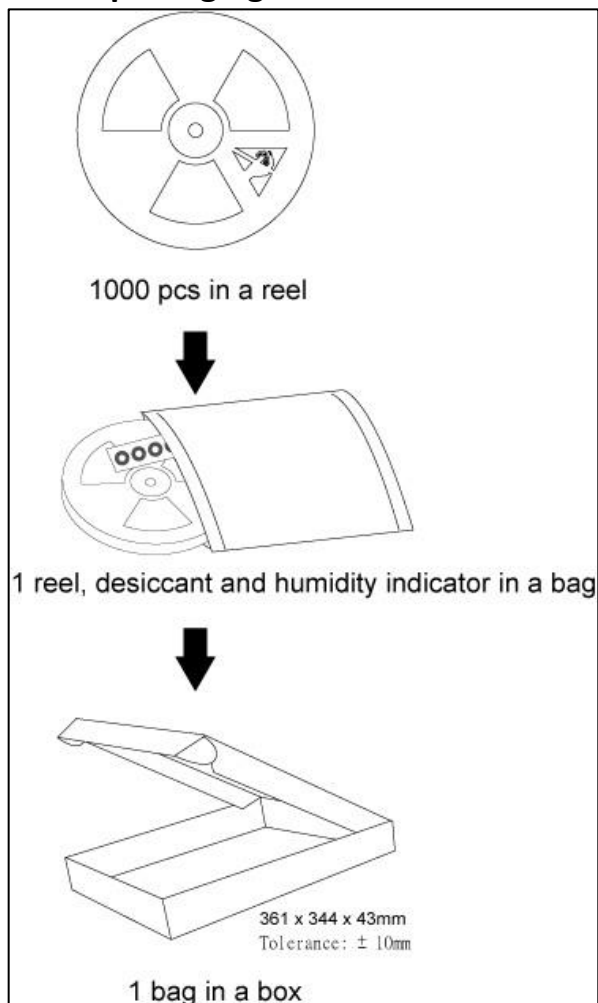


Figure 8: Box packaging

5.3 Moisture sensitivity level

The moisture sensitivity level of the module is 3. After the sealed bag is opened, modules should be mounted within 168 hours at factory conditions of $\leq 30^{\circ}\text{C}$ and 60% RH or stored at $\leq 20\%$ RH.

The modules require baking before mounting if above conditions are not met. If baking is required, the modules may be baked for:

- a. 192 hours at $40^{\circ}\text{C} + 5^{\circ}\text{C} / -0^{\circ}\text{C}$ and $< 5\%$ RH
- b. 24 hours at $125^{\circ}\text{C} + 5^{\circ}\text{C} / -0^{\circ}\text{C}$

5.4 Reflow soldering

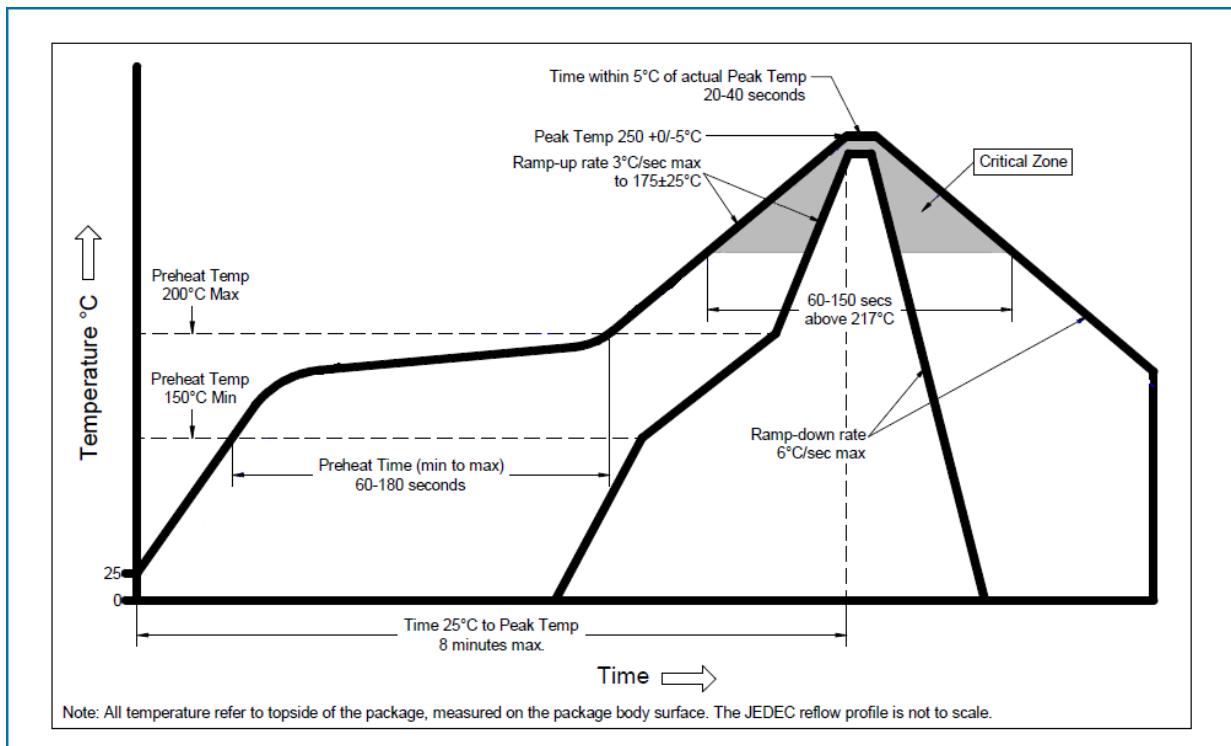


Figure 9: Recommended reflow profile

6. Product marking and ordering information

6.1. Product marking

The marking of GB-1916 is engraved on the metal shielding that has product information, such as LOCOSYS logo, product name, serial number, MAC address and manufacturing date.

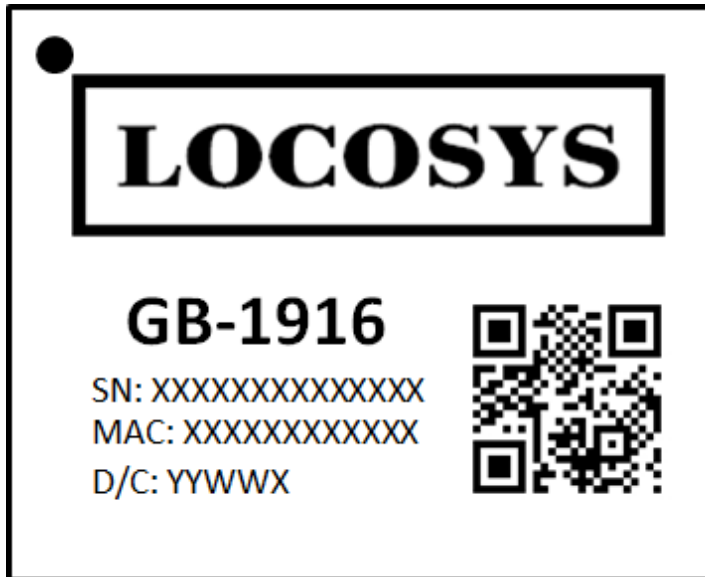


Figure 10: Label of GB-1916 module

6.2. Ordering information

Table 7: Ordering information

Product name	Description	Remark
GB-1916	GNSS/BT/BLE module	